

# Mobile Equipment Solutions

## SMARTPHONE

### Microscopic Components Mounting

- Compatible with 0201 components **PPS**

### Medium Temperature Board Mounting

- Solder paste compatible with high-speed printing **M40-LS720SP**
- Solder paste for reinforcing **M705-JPP**
- Non-wet open **M705-NWO**

### Cut-Off Fuse

- For the safety and security of battery circuits **Solder Clad**

### Component Terminal Coating

- Electrodes for coating **Pureloy Anode**
- Media for barrel coating **Solder Shot**

### Narrow-Pitch Connector Mounting

- $\Phi 0.1\text{mm}$  flux cored solder **EFC**

### Earphone

- High sound quality solder alloy

### VCM (Camera Module)

- Flux cored solder for preventing residue cracks **FORTE**

### Flexible Printed Circuits

- Sn-Ag-Cu solder suppressing residue cracks **M47-LS730HF**
- Water-soluble solder past **WSG36 Series**

### Low Temperature Shield Case Mounting

- Low temperature Sn-Bi-Ag solder **L23**
- **1005 Chip Solder**
- Solder fusion **Coat Case**

### Solder Replenishment in the TH section

- **0402 Chip Solder**
- **0603 Chip Solder**

### Semiconductor Package

- Solder ball for outer use **M770**
- Solder paste for bumps **BPS Series**
- Transfer solder paste **NSV320ZH**
- Ultra activated flux **MB-T100**
- Ultra lower residue flux **901K5**
- Transfer flux DELTALUX **GTN-68**
- Transfer solder sheet supporting narrow pitches **PPS**